PCN Number: 201701090					PCN Date:	Jan. 13, 2017				
Title	Datasheet for	r TRS202E				•				
Cus	tomer Contact:	PCN Manager					Dep	ot:	Quality Services	
Cha	nge Type:									
	Assembly Site			Design				Wafe	r Bump Site	
	Assembly Process		\boxtimes	Data Sheet				Wafer Bump Material		
	Assembly Materials			Part number change				Wafer Bump Process		
Щ	Mechanical Specification		Щ	Test Site				Wafer Fab Site		
	Packing/Shipping/Labeling			Test Process				Wafer Fab Materials		
Notification Details Wafer Fab Process									r Fab Process	
Description of Change:										
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details. TEXAS INSTRUMENTS										
	Instruments				SLL	S847	E-JUL	Y 2007-R	EVISED NOVEMBER 2016	
C	Changes from Revision D	(November 2012) to	o R	evision E					Page	
Mechanical, Packaging, and Orderable Information section										
Device Family			Change From:				Change To:			
TRS202E			SLLS847D					SLLS847E		
These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/TRS202E Reason for Change:										
			-1-	L L : -	-					
Ant No a		n Fit, Form,	Fu	ınction, Q	uality or Reli				itive / negative): ere are no changes	
Changes to product identification resulting from this PCN:										
Non										
	duct Affected:									
	5202ECD	TRS202ECDR			TRS202ECDRG4			ТЕ	RS202ECDWR	
l -	5202ECN	TRS202ECNE4	1		TRS202ECPW				RS202ECPWR	
l -	RS202ECPWRG4 TRS202EID		•	TRS202EIDR			TRS202EIDW			
l	TRS202EIDWR TRS202EIN			TRS202EINE4			TRS202EIPW			
l -	202EIPWG4 TRS202EIPWR			TRS202EIPWRG4						

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
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Asia Pacific	PCNAsiaContact@list.ti.com
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